Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	100	bond$3 near2 wire and (board shelf substrate) with (egde side) with plating with (layer strip) and (etching remov$3) with (conductive plating layer)	USPAT; EPO; JPO	OR	ON	2005/06/08 14:09
L2	0	bond$3 near2 wire and (board shelf substrate) with (egde side) with plating with (layer strip) and split$4 with (conductive plating layer) with (hole via)	USPAT; EPO; JPO	OR	ON	2005/06/08 14:09
L3	6	bond$3 near2 wire and (board shelf substrate) and (egde side) with plating with (layer strip) and (divid$3 split$4) with (conductive plating layer) with (hole via)	USPAT; EPO; JPO	OR	ON	2005/06/08 14:10
L4	23	(board shelf substrate) and (egde side) with plating with (layer strip) and (divid$3 split$4) with (conductive plating layer) with (hole via)	USPAT; EPO; JPO	OR	ON	2005/06/08 14:10
L5	3	("4638348" | "5006792" | "5672909").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/08 14:11
L6	11	("4410905" | "4839717" | "5008734" | "5173767" | "5225709" | "5294751" | "5329156" | "5343074" | "5402318" | "5457340" | "5497031").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/08 14:12
L7	5	("5008734" | "5214845" | "5225709" | "5227583" | "5294751").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/08 14:15
L8	2	("4396795" | "4925024").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/08 14:16
L9	3	("4922324" | "4972253" | "5043794").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/08 14:16
L10	61	("4972253").URPN.	USPAT	OR	ON	2005/06/08 14:17
S1	23	("4223321"|"4891687"|"0468270"|"5089878"|"5206986"|"5218515"|"5488257"|"5491632"|"5557502"|"5625166"|"5726860"|"5777265"|"5787575"|"5801450"|"5858816"|"5877553"|"5880529"|"6008532"|"6014809"|"6020631"|"6031283"|"6073344"|"6153829").PN.	USPAT; EPO; JPO	OR	ON	2005/06/07 18:29
S2	2	carapella.in. and circuit.ti.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2005/06/07 18:30

S3	4	("5491362" | "5557502" | "5877553" | "6008532").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/07 18:30
S4	1	bond$3 near2 shelf with plat$3 and conductive near2 strip	USPAT; EPO; JPO	OR	ON	2005/06/07 18:34
S5	8	bond$3 near2 shelf with plat$3	USPAT; EPO; JPO	OR	ON	2005/06/07 18:35
S6	50	bond$3 near2 wire and shelf with plat$3	USPAT; EPO; JPO	OR	ON	2005/06/07 18:41
S7	9	bond$3 near2 wire and shelf with plating	USPAT; EPO; JPO	OR	ON	2005/06/07 18:49
S8	17	("3349480" | "4660063" | "4711026" | "4859807" | "5096849" | "5104684" | "5126532" | "5196376" | "5455998" | "5487218" | "5569398" | "5613858" | "5811019" | "5856636" | "5881455" | "5906042").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/07 18:42
S9	10	("4420767" | "4819041" | "4899118" | "5218515" | "5285352" | "5291062" | "5355283" | "5357672" | "5400220" | "5442852").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/07 18:46
S10	3	("5102829" | "5130889" | "5357672").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/07 18:48
S11	837	bond$3 near2 wire and (egde side) with plating	USPAT; EPO; JPO	OR	ON	2005/06/07 18:49
S12	304	bond$3 near2 wire and (board shelf substrate) with (egde side) with plating	USPAT; EPO; JPO	OR	ON	2005/06/07 18:49
S13	138	bond$3 near2 wire and (board shelf substrate) with (egde side) with plating with (layer strip)	USPAT; EPO; JPO	OR	ON	2005/06/08 14:02
S14	1	"4223321".pn.	USPAT; EPO; JPO	OR	ON	2005/06/08 09:46